

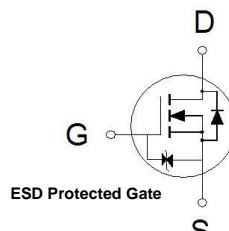
**NIKO-SEM****N-Channel Enhancement Mode  
Field Effect Transistor****PK5M2EN**

PDFN 5x6PX

Halogen-Free &amp; Lead-Free

**PRODUCT SUMMARY**

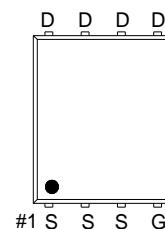
| $V_{(BR)DSS}$ | $R_{DS(on)}$ | $I_D$ |
|---------------|--------------|-------|
| 40V           | 2.9mΩ        | 134A  |

**Features**

- Pb-Free, Halogen Free and RoHS compliant.
- Low  $R_{DS(on)}$  to Minimize Conduction Losses.
- Ohmic Region Good  $R_{DS(on)}$  Ratio.
- Optimized Gate Charge to Minimize Switching Losses.
- Products Integrated ESD diode with ESD Protected.
- 100% UIS Tested & Rg Tested.

**Applications**

- Protection Circuits Applications.
- Computer for DC to DC Converters Applications.



G. GATE  
D. DRAIN  
S. SOURCE

100% UIS Tested  
100% Rg Tested

**ABSOLUTE MAXIMUM RATINGS ( $T_A = 25^\circ\text{C}$  Unless Otherwise Noted)**

| PARAMETERS/TEST CONDITIONS                     |                           | SYMBOL         | LIMITS     | UNITS |
|--|---------------------------|----------------|------------|-------|
| Drain-Source Voltage                           |                           | $V_{DS}$       | 40         | V     |
| Gate-Source Voltage                            |                           | $V_{GS}$       | $\pm 25$   | V     |
| Continuous Drain Current <sup>4</sup>          | $T_C = 25^\circ\text{C}$  | $I_D$          | 134        | A     |
|  | $T_C = 100^\circ\text{C}$ |                | 84         |       |
| Pulsed Drain Current <sup>1</sup>              |                           | $I_{DM}$       | 300        |       |
| Continuous Drain Current                       | $T_A = 25^\circ\text{C}$  | $I_D$          | 27         | A     |
|  | $T_A = 70^\circ\text{C}$  |                | 21         |       |
| Avalanche Current                              |                           | $I_{AS}$       | 80         |       |
| Avalanche Energy                               | $L = 0.1\text{mH}$        | $E_{AS}$       | 320        | mJ    |
| Power Dissipation                              | $T_C = 25^\circ\text{C}$  | $P_D$          | 104        | W     |
|  | $T_C = 100^\circ\text{C}$ |                | 42         |       |
| Power Dissipation <sup>3</sup>                 | $T_A = 25^\circ\text{C}$  | $P_D$          | 4.3        | W     |
|  | $T_A = 70^\circ\text{C}$  |                | 2.8        |       |
| Operating Junction & Storage Temperature Range |                           | $T_j, T_{stg}$ | -55 to 150 | °C    |

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**THERMAL RESISTANCE RATINGS**

| THERMAL RESISTANCE               |              | SYMBOL          | TYPICAL | MAXIMUM | UNITS  |
|----------------------------------|--------------|-----------------|---------|---------|--------|
| Junction-to-Ambient <sup>2</sup> | $t \leq 10s$ | $R_{\theta JA}$ |         | 29      | °C / W |
| Junction-to-Ambient <sup>2</sup> | Steady-State | $R_{\theta JA}$ |         | 64      |        |
| Junction-to-Case                 | Steady-State | $R_{\theta JC}$ |         | 1.2     |        |

<sup>1</sup>Pulse width limited by maximum junction temperature.<sup>2</sup>The value of  $R_{\theta JA}$  is measured with the device mounted on 1in<sup>2</sup> FR-4 board with 2oz. Copper, in a still air environment with  $T_A = 25^\circ C$ .<sup>3</sup>The Power dissipation is based on  $R_{\theta JA} t \leq 10s$  value.<sup>4</sup>The maximum current rating is package limited.**ELECTRICAL CHARACTERISTICS ( $T_J = 25^\circ C$ , Unless Otherwise Noted)**

| PARAMETER                                     | SYMBOL        | TEST CONDITIONS   | LIMITS |      |          | UNIT      |
|---|---------------|---|--------|------|----------|-----------|
|   |               |   | MIN    | TYP  | MAX      |           |
| <b>STATIC</b>                                 |               |   |        |      |          |           |
| Drain-Source Breakdown Voltage                | $V_{(BR)DSS}$ | $V_{GS} = 0V, I_D = 250\mu A$                                 | 40     |      |          |           |
| Gate Threshold Voltage                        | $V_{GS(th)}$  | $V_{DS} = V_{GS}, I_D = 250\mu A$                             | 1.3    | 1.6  | 2.3      | V         |
| Gate-Body Leakage                             | $I_{GSS}$     | $V_{DS} = 0V, V_{GS} = \pm 20V$                               |        |      | $\pm 10$ | $\mu A$   |
| Zero Gate Voltage Drain Current               | $I_{DSS}$     | $V_{DS} = 40V, V_{GS} = 0V$                                   |        |      | 1        | $\mu A$   |
|   |               | $V_{DS} = 40V, V_{GS} = 0V, T_J = 55^\circ C$                 |        |      | 10       |           |
| Drain-Source On-State Resistance <sup>1</sup> | $R_{DS(ON)}$  | $V_{GS} = 4.5V, I_D = 20A$                                    |        | 3.8  | 6        | $m\Omega$ |
|   |               | $V_{GS} = 10V, I_D = 20A$                                     |        | 2.3  | 2.9      |           |
| Forward Transconductance <sup>1</sup>         | $g_{fs}$      | $V_{DS} = 5V, I_D = 20A$                                      |        | 22   |          | S         |
| <b>DYNAMIC</b>                                |               |   |        |      |          |           |
| Input Capacitance                             | $C_{iss}$     | $V_{GS} = 0V, V_{DS} = 20V, f = 1MHz$                         |        | 5469 |          | pF        |
| Output Capacitance                            | $C_{oss}$     |   |        | 804  |          |           |
| Reverse Transfer Capacitance                  | $C_{rss}$     |   |        | 415  |          |           |
| Gate Resistance                               | $R_g$         | $V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$                          |        | 2    |          | $\Omega$  |
| Total Gate Charge <sup>2</sup>                | $Q_g$         | $V_{DS} = 20V, V_{GS} = 10V, I_D = 20A$                       |        | 94   |          | nC        |
|   |               |   |        | 47   |          |           |
| Gate-Source Charge <sup>2</sup>               | $Q_{gs}$      |   |        | 19   |          |           |
| Gate-Drain Charge <sup>2</sup>                | $Q_{gd}$      |   |        | 18   |          |           |
| Turn-On Delay Time <sup>2</sup>               | $t_{d(on)}$   |   |        | 23   |          |           |
| Rise Time <sup>2</sup>                        | $t_r$         |   |        | 83   |          |           |
| Turn-Off Delay Time <sup>2</sup>              | $t_{d(off)}$  | $V_{DS} = 20V, I_D \geq 20A, V_{GS} = 10V, R_{GEN} = 6\Omega$ |        | 106  |          | nS        |
| Fall Time <sup>2</sup>                        | $t_f$         |   |        | 111  |          |           |

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**SOURCE-DRAIN DIODE RATINGS AND CHARACTERISTICS ( $T_J = 25^\circ\text{C}$ )**

|                                 |          |   |  |    |     |    |
|---------------------------------|----------|---|--|----|-----|----|
| Continuous Current <sup>3</sup> | $I_S$    |   |  |    | 87  | A  |
| Forward Voltage <sup>1</sup>    | $V_{SD}$ | $I_F = 20\text{A}, V_{GS} = 0\text{V}$                  |  |    | 1.2 | V  |
| Reverse Recovery Time           | $t_{rr}$ | $I_F = 20\text{A}, dI_F/dt = 400\text{A} / \mu\text{s}$ |  | 40 |     | nS |
| Reverse Recovery Charge         | $Q_{rr}$ |   |  | 95 |     | nC |

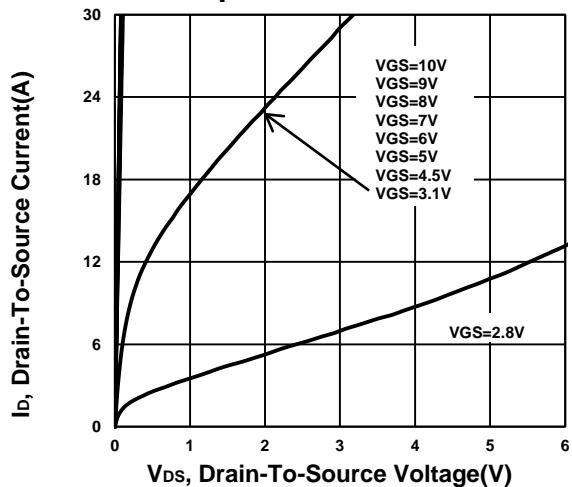
<sup>1</sup>Pulse test : Pulse Width  $\leq 300 \mu\text{sec}$ , Duty Cycle  $\leq 2\%$ .<sup>2</sup>Independent of operating temperature.<sup>3</sup>The maximum current rating is package limited.

**NIKO-SEM**

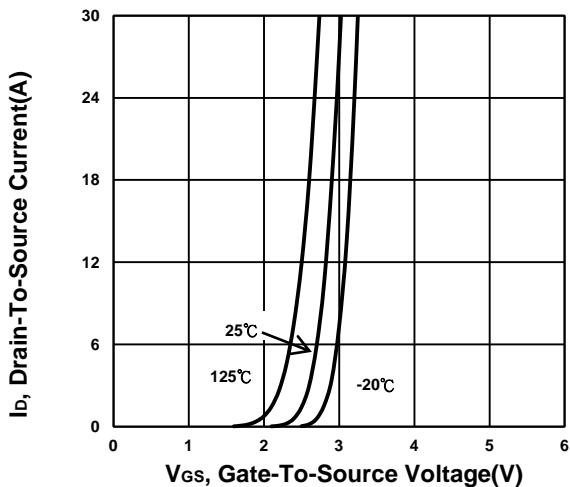
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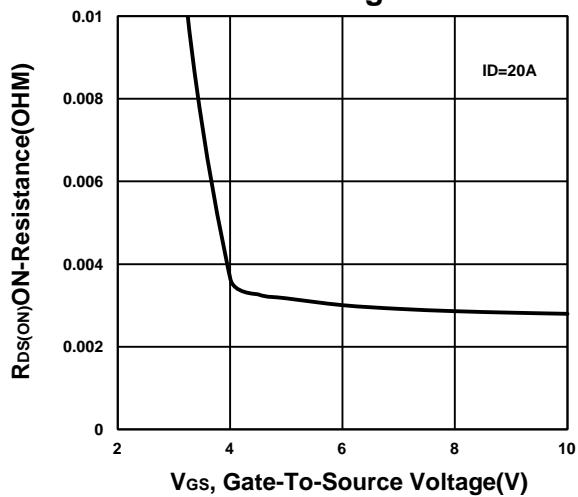
### Output Characteristics



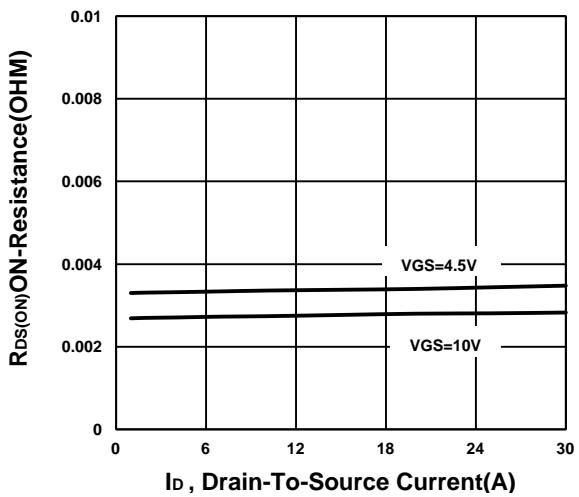
### Transfer Characteristics



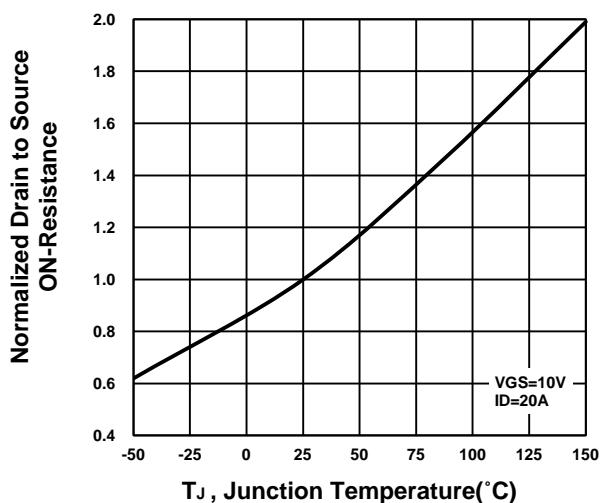
### On-Resistance VS Gate-To-Source Voltage



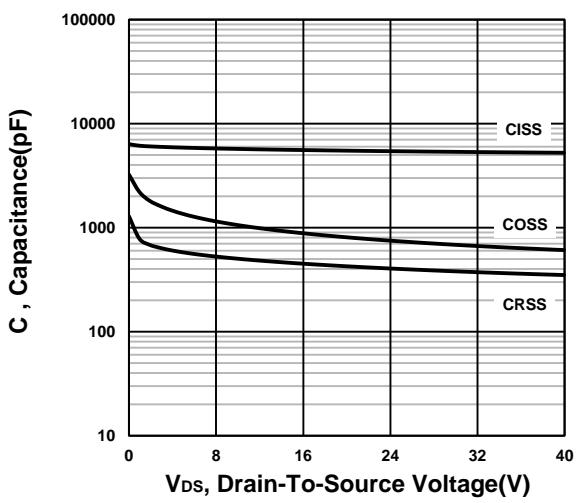
### On-Resistance VS Drain Current



### On-Resistance VS Temperature



### Capacitance Characteristic

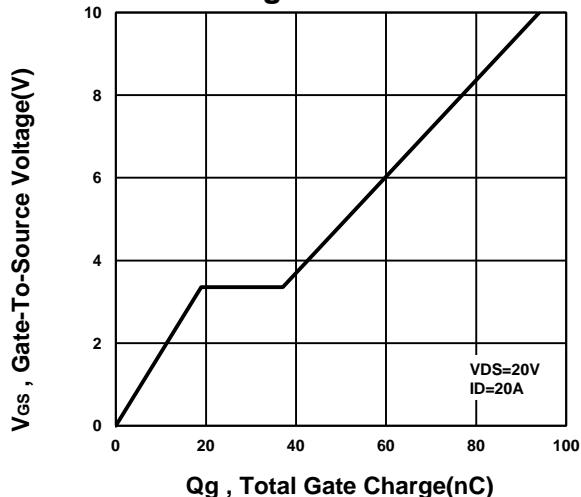


**NIKO-SEM**

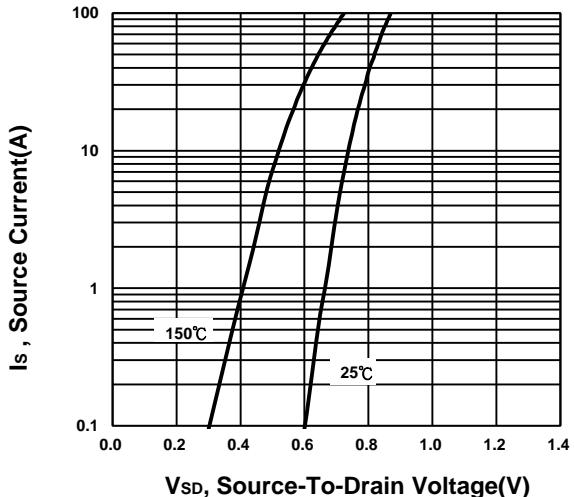
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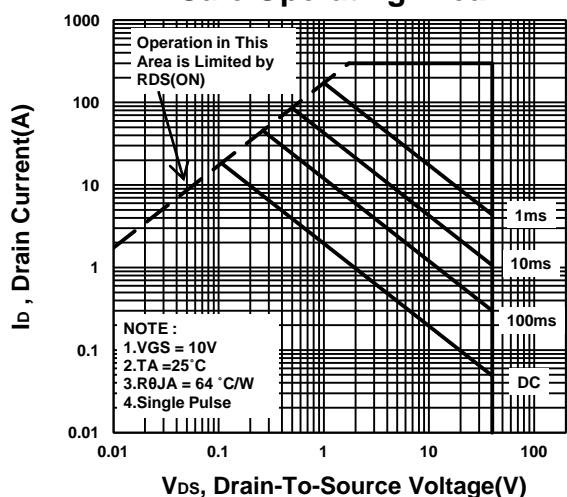
### Gate charge Characteristics



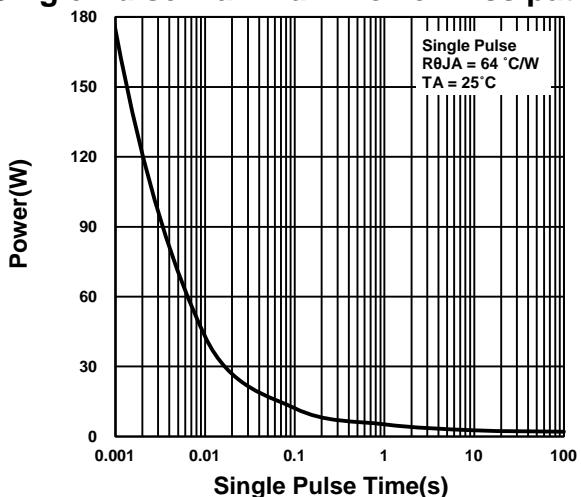
### Source-Drain Diode Forward Voltage



### Safe Operating Area



### Single Pulse Maximum Power Dissipation



### Transient Thermal Response Curve

